



- NOTES:
1. PLATING THICKNESS TO BE PER CUSTOMER'S SPECIFICATION.
 2. SEAL AREA TO BE METALLIZED.
 3. DIE ATTACH AREA TO BE METALLIZED.
 4. SEAL RING AND DIE ATTACH PAD TO BE FLOATING FROM ANY PINS.
 5. LEAD RESISTANCE : 0.300 MAX.

AUG 02 '88 09:33 KYOCERA BOSTON

VENDOR'S OPTION

SB024U526-1

				NAME	24 LEAD SIDE BRAZED PACKAGE	TOLERANCE	±.005	DRAWN	CHECKED	APPROVED	DATE	
				SCALE	4/1	MATERIAL	AS INDICATED	S.F.	A.F.	K.K.	T.A.	
CHANGED: W/S				AUG. 02 '88	H.Y.	A.F.	K.K.	T.A.				KYOCERA CORPORATION KYOTO JAPAN
CHANGED				DATE	DRAWN	CHECKED	APPROVED	KYOCERA KYOTO JAPAN			KO-588526-A	

